



Product Change Notification

113036 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 113036 - 00
Change Title: Intel® Compute Module HNS2600WP
PCN 113036-00, Product Material
Update Integrated Baseboard Management
Control (BMC) Chip
Date of Publication: May 23, 2014

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	Jun 07, 2014
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Compute Module HNS2600WP:

1. The Integrated Baseboard Management Controller (BMC) chip has been updated to revision P02, because the previous revision P01 is end of life. BMC P01 cannot read data with 8-byte commands from the Field Replaceable Unit (FRU) on the IO module when enabling PCA9546 with more than one channel. The issue is fixed in BMC P02. Testing has been done and the functionality change is transparent to the customer.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Customers may need to validate the function and feature changes after receiving the system.

Products Affected / Intel Ordering Codes:

ASMO SKU			
Product Code	MM#	Pre Change TA	Post Change TA
HNS2600WP	918378	G54635-001	G54635-002

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
May 23, 2014	00	Originally Published PCN